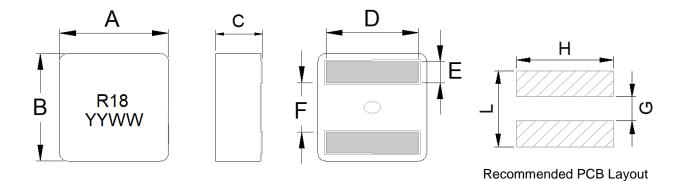
1. Part No. Expression

<u>PIF0603 A R18 M N</u>

(a) (b) (c) (d) (e) (f)

- (a) Series Code
- (b) Dimension Code
- (c) Material Code
- (d) Inductance Code
- (e) Tolerance Code
- (f) Special Code

2. Configuration & Dimensions (Unit: mm)



Note: 1. The above PCB layout reference only.

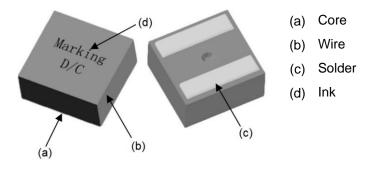
2. Recommend solder paste thickness at 0.15 mm and above.

3. Marking: Top= Inductance Code, Bottom=YYWW (Year/World week)

Inductance Range	А	В	С	D	Е	F	L	G	Н
1.2uH and below	0.00.0.00	6 40 . 0 00	2.80±0.20	See Electrical	1 10 - 0 20	0.00.0.05	5 00 Def	2 50 Def	
1.5uH and above	6.60±0.20	6.40±0.20	2.90±0.20	Characteristics Table	1.40±0.20	2.60±0.25	5.60 Ref	2.50 Ref	5.60 Rei



3. Material List



4. General Specifications

- (a) Operating Temp.: -40°C to +125°C (including self-temperature rise)
- (b) Storage Temp.: -40°C to +125°C (on board)
- (c) All test data referenced to 25°C ambient.
- (d) Heat Rated Current (Irms) will cause the coil temperature rise approximately ΔT of 20°C & 40°C
- (e) Saturation Current (Isat) will cause inductance L0 to drop approximately 30%.
- (f) Part Temperature (Ambient + Temp. Rise): Should not exceed 125°C under worst case operating conditions.
- (g) Maximum operating voltage: 40V
- (h) Storage Condition (Component in its packaging)
 - i) Temperature: Less than 40°C
 - ii) Humidity: Less than 60% RH



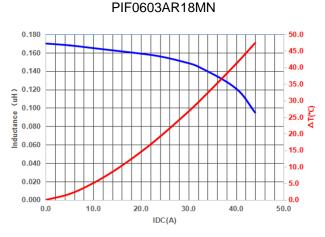
Part Number		I rms(A	A) Тур.	I sat(A)		DCR (mΩ)		D	SRF (MHz)	Q
Fait Number	(uH)@0A ±20%	@20°C	@40°C	Тур	Max	Тур	Max	(mm) ±0.3	Ref	Min
PIF0603AR18MN	0.18	24.0	32.0	40.0	36.0	1.60	1.75	5.30	143	15
PIF0603AR33MN	0.33	20.0	25.0	32.0	28.0	2.25	2.50	5.55	78	15
PIF0603AR56MN	0.56	17.0	22.0	29.0	25.0	3.00	3.31	5.30	70	15
PIF0603A1R0MN	1.00	13.0	18.0	23.0	18.0	5.50	6.05	5.20	52	20
PIF0603A1R2MN	1.20	12.0	16.0	22.0	16.0	6.70	7.40	5.15	47	20
PIF0603A1R8MN	1.80	10.0	14.0	18.2	13.0	9.20	10.2	5.10	33	20
PIF0603A2R2MN	2.20	7.00	10.0	15.9	11.0	11.0	12.2	5.05	29	20
PIF0603A3R3MN	3.30	6.00	8.00	12.2	9.00	18.8	20.8	5.00	25	20
PIF0603A4R5MN	4.50	5.00	7.00	10.0	8.00	23.0	25.3	5.00	20	20

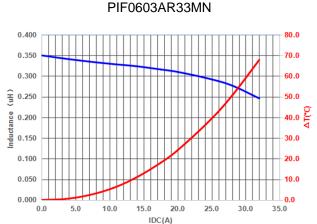
5. Electrical Characteristics

Test Frequency: 0.1V/100kHz

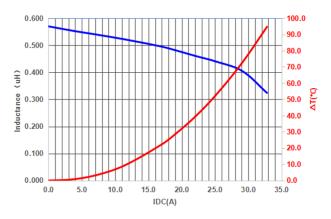


6. Characteristics Curve

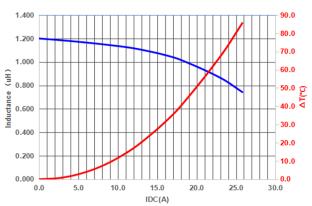


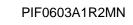


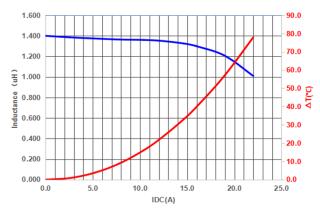
PIF0603AR56MN



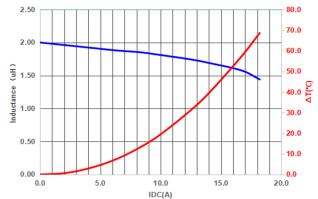
PIF0603A1R0MN







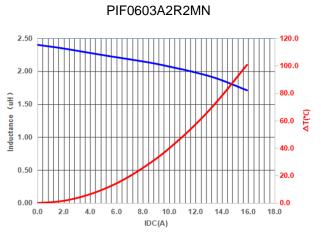
PIF0603A1R8MN

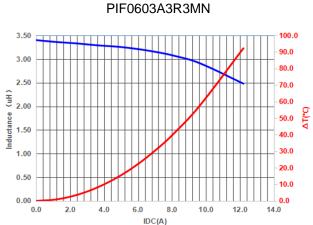


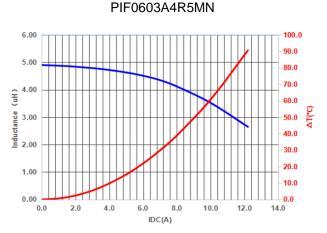
NOTE: Specifications subject to change without notice. Please check our website for latest information.



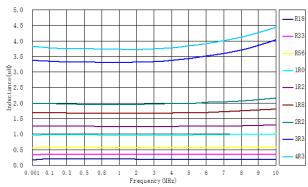
P3







PIF0603A Series





7. Soldering Specification

Mildly activated rosin fluxes are preferred. Our terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

7-1. IR Soldering Reflow

Recommended temperature profiles for lead free re-flow soldering in Figure 1, Table 1.1 & 1.2 (J-STD-020E).

7-2. Iron Reflow

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended (Figure 2).

Note:

- (a) Preheat circuit and products to 150°C.
- (b) 355°C tip temperature (Max.)
- (c) Never contact the ceramic with the iron tip
- (d) 1.0mm tip diameter (Max.)
- (e) Use a 20 watt soldering iron with tip diameter of 1.0mm
- (f) Limit soldering time to 4~5 sec.

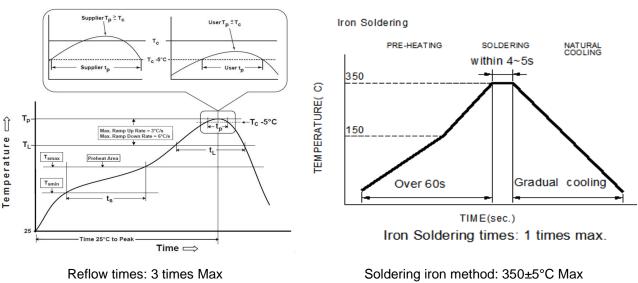


Figure 1: IR Soldering Reflow

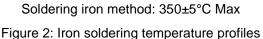




Table (1.1) Reflow Profiles

Profile Type:	Pb-Free Assembly
Preheat	
-Temperature Min (T _{smin})	150°C
-Temperature Max (T _{smax})	200°C
-Time (t _s) from (T _{smin} to T _{smax})	60-120seconds
Ramp-up rate (T∟to T _p)	3°C /second max.
Liquids temperature (T _L)	217°C
Time (t∟) maintained above T∟	60-150 seconds
Classification temperature (T _c)	See Table (1.2)
Time (t_p) at Tc- 5°C (Tp should be equal to or less than Tc.)	*< 30 seconds
Ramp-down rate (T _p to T _L)	6°C /second max.
Time 25°C to peak temperature	8 minutes max.

 $\ensuremath{\text{Tp}}$: maximum peak package body temperature, $\ensuremath{\text{Tc}}$: the classification temperature.

For user (customer) $\ensuremath{\text{Tp}}$ should be equal to or less than $\ensuremath{\text{Tc.}}$

*Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

· · ·	0		•	()
	Package	Volume mm ³	Volume mm ³	Volume
	Thickness	<350	350-2000	mm ³ >2000
PB-Free	<1.6mm	260°C	260°C	260°C
	1.6-2.5mm	260°C	250°C	245°C
Assembly	≥2.5mm	250°C	245°C	245°C

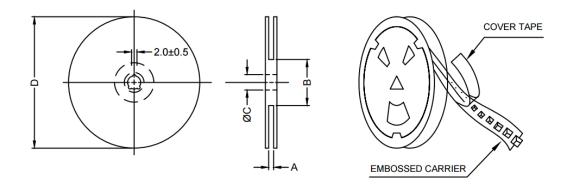
Table (1.2) Package Thickness/Volume and Classification Temperature (T_c)

Reflow is referred to standard IPC/JEDEC J-STD-020E.



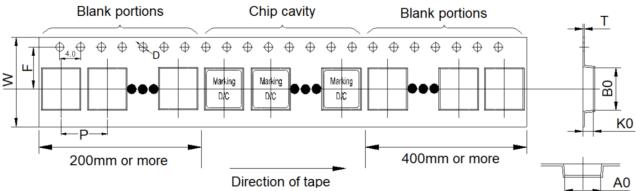
8. Packaging Information

8-1. Reel Dimension (Unit: mm)



Туре	А	В	С	D
13"x16mm	16.4+2.0/-0.0	100.0±2.0	13.0+0.5/-0.2	330.0

8-2. Tape Dimension (Unit: mm)



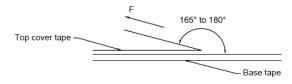
B0	A0	K0	Р	W	F	т	D
6.80±0.10	7.00±0.10	3.30±0.10	12.00±0.10	16.00±0.30	7.50±0.10	0.35±0.05	1.50±0.10



8-3. Packaging Quantity (Unit: Pcs)

Chip/ Reel	1,000		
Inner Box	2,000		
Carton	8,000		

8-4. Tearing Off Force



The force for tearing off cover tape is according to the follow table, in the arrow direction under the following conditions.

(Referenced ANSI/EIA-481-D-2008 of 4.11 standard)

Room	Room	Poom atm	Room atm Tearing Tap		Tape Size	8 mm	12 to 56 mm
Temp. (°C)	Humidity (%)	(hPa)	Speed (mm/min)	Tearing Off Force	10~100	10~130	
5~35	45~85	860~1060	300±10		(grams)		

Application Notice

1. Storage Conditions

To maintain the solderability of terminal electrodes:

- (a) Recommended products should be used within 12 months from the time of delivery.
- (b) The packaging material should be kept where no chlorine or sulfur exists in the air.
- 2. Transportation
 - (a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
 - (b) Vacuum pick up is strongly recommended for individual components.
 - (c) Bulk handling should ensure that abrasion and mechanical shock are minimized.

NOTE: Specifications subject to change without notice. Please check our website for latest information.



72 mm or Wider

10~150